

Coiltronics MPIA4040

Automotive Grade

High Current, High Frequency, Miniature Power Inductors



Product description:

- AEC-Q200 Grade 3 qualified
- Handles high transient inrush current spikes
- Magnetically shielded
- Frequency range 20kHz to 10MHz
- Inductance range from 0.09µH to 22µH
- Current range from 1.1A to 32.0A
- 4.7 x 4.31 footprint surface mount package in 1.2, 1.5, 1.85 or 2.0mm heights
- Rugged construction
- Halogen free, lead free, RoHS compliant

Applications:

- Body electronics
 - Central body control module
 - Vehicle access control system
 - Headlamps, tail lamps and interior lighting
 - Door control
- Advanced driver assistance systems
 - 77GHz radar systems
 - Automatic parking control
 - Collision avoidance system
 - Basic and smart surround, and rear and front view camera
 - Adaptive Cruise Control (ACC)
 - Car black box system
- Infotainment and cluster electronics
 - Active noise cancellation (ANC)
 - Audio subsystem: head unit and trunk amp
 - Digital instrument cluster
 - In-vehicle infotainment (IVI) and navigation
 - Port power/USB hub for front and rear passengers
- Chassis and safety electronics
 - Airbag control unit

Environmental data:

- Storage temperature range (component): -55°C to +125°C
- Operating temperature range: -55°C to +125°C (ambient plus self temperature rise)
- Solder reflow temperature: J-STD-020D compliant



The Coiltronics brand of magnetics (formerly of the Bussmann Division of Cooper Industries) is now part of Eaton's Electrical Group, Electronics Division.

Coiltronics is now part of Eaton
Same great products plus even more.



Powering Business Worldwide

Product specifications

Part Number ⁵	OCL ¹ ± 20% (μH)	Part Marking Designator	I _{rms} ² (Amps)	I _{sat} ³ @ 25°C (Amps)	DCR (mΩ) ± 20% @ 20°C	K-factor ⁴
R1 -- 1.2mm Height						
MPIA4040R1-R10-R	0.09	A	8.00	32.0†	8.50	1401
MPIA4040R1-R15-R	0.15	B	7.00	26.0†	11.0	989
MPIA4040R1-R22-R	0.23	C	5.50	21.0	18.0	814
MPIA4040R1-R33-R	0.33	D	4.40	17.0	28.0	659
MPIA4040R1-R47-R	0.47	E	5.20	11.5	20.0	1295
MPIA4040R1-R68-R	0.68	F	3.30	9.00	51.0	461
MPIA4040R1-1R0-R	1.0	G	3.70	7.70	40.0	990
MPIA4040R1-1R5-R	1.5	H	3.00	6.50	60.0	732
MPIA4040R1-2R2-R	2.2	I	2.60	5.90	80.0	623
MPIA4040R1-3R3-R	3.3	J	2.20	5.10	115	481
MPIA4040R1-4R7-R	4.7	K	1.80	3.80	180	411
MPIA4040R1-6R8-R††	6.8	L	1.50	3.20	250	344
MPIA4040R1-100-R††	10.0	M	1.20	2.80	370	276
R2 -- 1.5mm Height						
MPIA4040R2-R47-R	0.47	A	6.40	12.2	13.0	1403
MPIA4040R2-1R0-R	1.0	B	4.60	8.90	25.0	935
MPIA4040R2-1R5-R	1.5	C	3.80	7.60	37.0	701
MPIA4040R2-2R2-R	2.2	D	3.20	5.70	58.0	647
MPIA4040R2-3R3-R	3.3	E	2.60	5.40	76.0	495
MPIA4040R2-4R7-R	4.7	F	2.20	4.30	105	421
MPIA4040R2-6R8-R	6.8	G	1.80	3.40	158	351
MPIA4040R2-100-R††	10.0	H	1.50	3.10	240	271

- 1 Open Circuit Inductance (OCL) Test Parameters: 100kHz, 0.10V_{rms}, 0.0A_{dc}
- 2 I_{rms}: DC current for an approximate temperature rise of 40°C without core loss. De-rating is necessary for AC currents. Temperature rise is dependent upon several factors, including the PCB pad layout, trace thickness and width, air-flow and proximity to other heat generating components. It is recommended the part temperature not exceed 125°C under worst case operating conditions and therefore, the temperature rise should be verified in the end use application. Irms testing was performed on a 19.05mm long x 6.35mm wide x 0.070mm thick copper trace in still air.
- 3 I_{sat}: Peak current for approximately 30% rolloff at +25°C.

- 4 K-factor: Used to determine B_{p-p} for core loss (see graph). B_{p-p} = K * L * DI. Bp-p : (Gauss), K: (K-factor from table), L: (inductance in μH), DI (peak-to-peak ripple current in amps).
- 5 Part Number Definition: MPIA4040RX-XXX-R
- MPIA4040X = product code and size
 - XXX = inductance value in all, "R" = decimal point
 - If no "R" is present, then third digit equals the number of zeros
 - "-R" suffix = RoHS compliant
- † Transient pulse not to exceed 1 millisecond.
- †† Maximum operating frequency less than 10MHz, consult factory for application specific values.

Part Number ⁵	OCL ¹ ± 20% (μH)	Part Marking Designator	I _{rms} ² (Amps)	I _{sat} ³ @ 25°C (Amps)	DCR (mΩ) ± 20% @ 20°C	K-factor ⁴
R3 -- 1.85mm Height						
MPIA4040R3-R22-R	0.22	A	8.00	20.0	5.8	1870
MPIA4040R3-R47-R	0.47	B	5.80	17.0	10.3	1530
MPIA4040R3-1R2-R	1.2	C	4.00	9.40	32.0	732
MPIA4040R3-1R5-R	1.5	D	3.80	8.20	36.0	673
MPIA4040R3-2R2-R	2.2	E	3.40	7.90	48.0	543
MPIA4040R3-3R3-R	3.3	F	3.00	6.60	60.0	432
MPIA4040R3-4R7-R	4.7	G	2.30	4.80	92.0	374
MPIA4040R3-6R8-R	6.8	H	2.00	4.50	120	306
MPIA4040R3-100-R	10.0	I	1.50	3.80	213	251
MPIA4040R3-150-R	15.0	J	1.30	3.00	285	213
MPIA4040R3-220-R ^{††}	22.0	K	1.10	2.20	408	174
R4 -- 2.0mm Height						
MPIA4040R4-R22-R	0.22	A	10.1	15.0	5.3	2405
MPIA4040R4-R33-R	0.33	B	9.50	12.8	6.0	1870
MPIA4040R4-R47-R	0.45	C	8.10	11.5	8.2	1530
MPIA4040R4-1R0-R	1.0	D	5.70	8.20	17.0	990
MPIA4040R4-1R5-R	1.5	E	4.90	6.90	23.0	802
MPIA4040R4-2R2-R	2.2	F	3.90	5.70	35.0	673
MPIA4040R4-3R3-R ^{††}	3.3	G	3.30	4.50	49.0	510
MPIA4040R4-4R7-R ^{††}	4.7	H	2.90	3.90	67.0	455
MPIA4040R4-6R8-R ^{††}	6.8	I	2.40	3.20	91.0	374
MPIA4040R4-100-R ^{††}	10.0	J	1.90	2.60	148	306
MPIA4040R4-220-R ^{††}	22.0	K	1.30	1.80	316	203

1 Open Circuit Inductance (OCL) Test Parameters: 100kHz, 0.10V_{rms}, 0.0A_{dc}

2 I_{rms}: DC current for an approximate temperature rise of 40°C without core loss. De-rating is necessary for AC currents. Temperature rise is dependent upon several factors, including the PCB pad layout, trace thickness and width, air-flow and proximity to other heat generating components. It is recommended the part temperature not exceed 125°C under worst case operating conditions and therefore, the temperature rise should be verified in the end use application. Irms testing was performed on a 19.05mm long x 6.35mm wide x 0.070mm thick copper trace in still air.

3 I_{sat}: Peak current for approximately 30% rolloff at +25°C.

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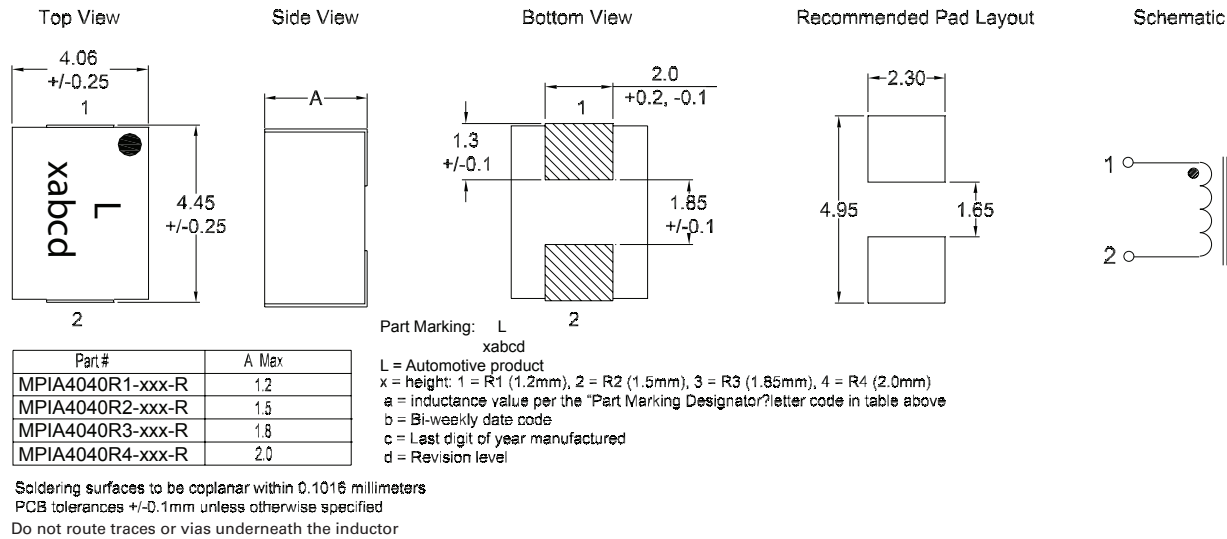
5 Part Number Definition: MPIA4040RX-XXX-R

- MPIA4040X = product code and size
- XXX = inductance value in all, "R" = decimal point
- If no "R" is present, then third digit equals the number of zeros
- "-R" suffix = RoHS compliant

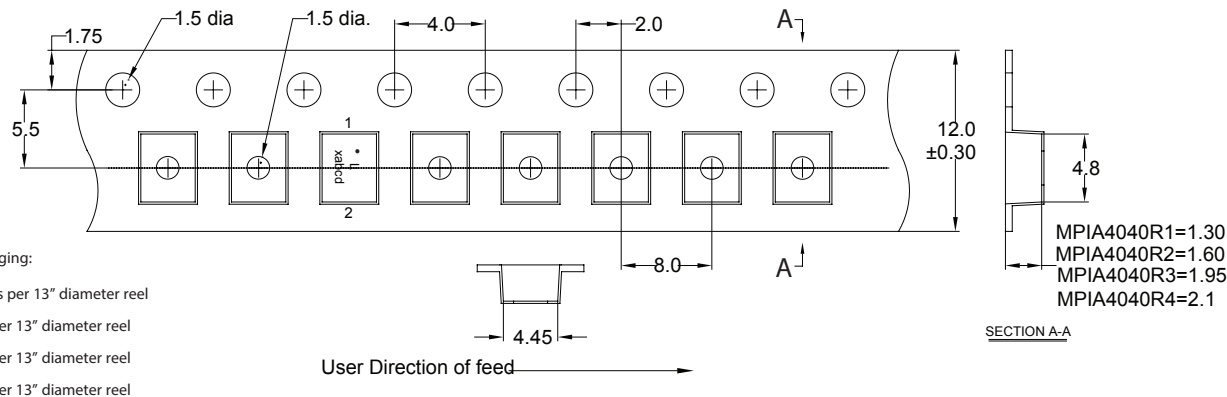
† Transient pulse not to exceed 1 millisecond.

†† Maximum operating frequency less than 10MHz, consult factory for application specific values.

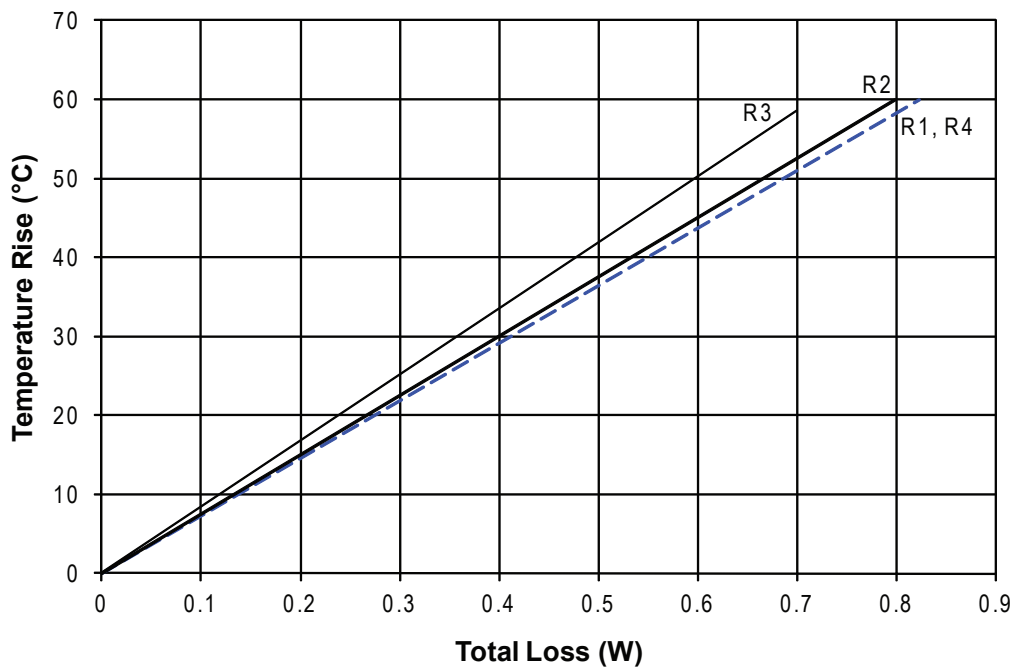
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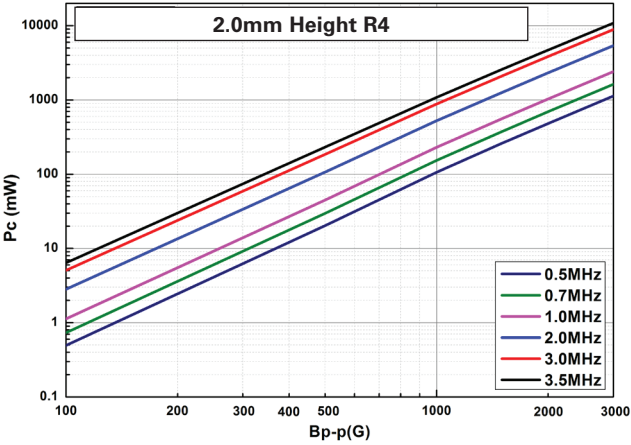
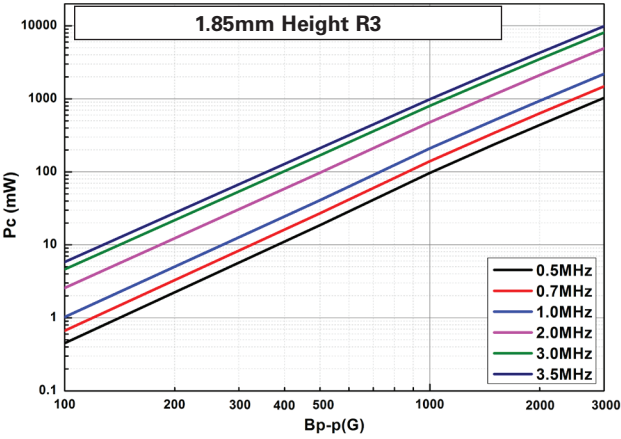
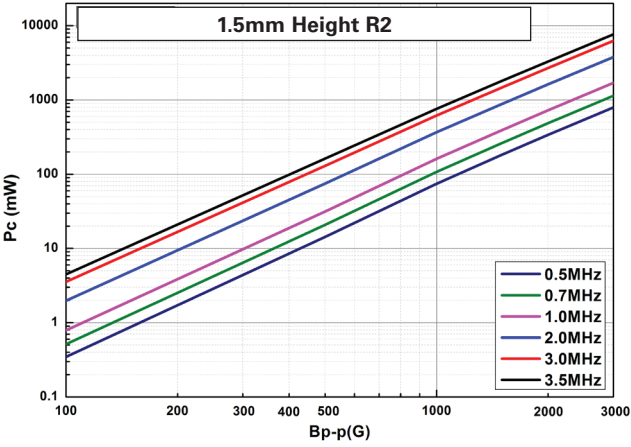
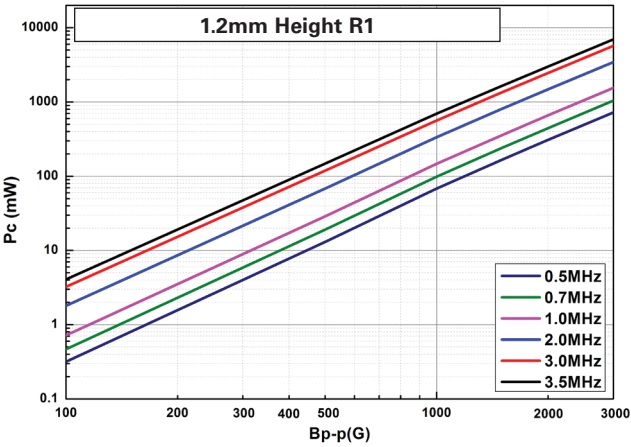
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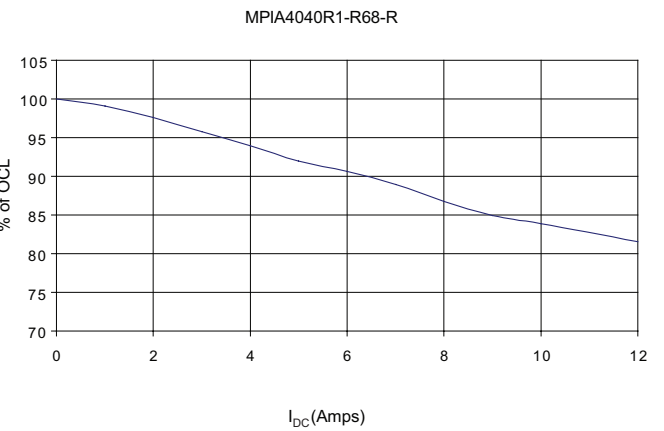
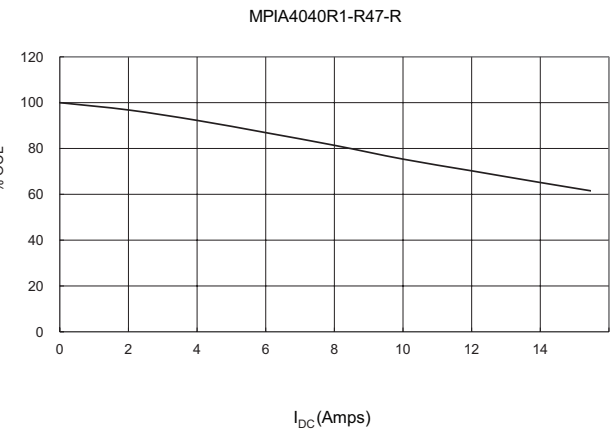
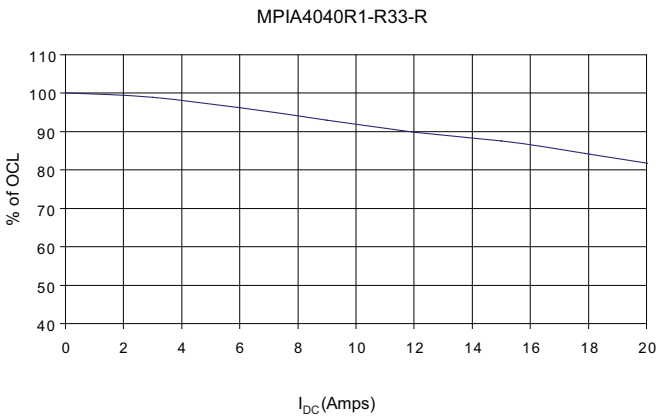
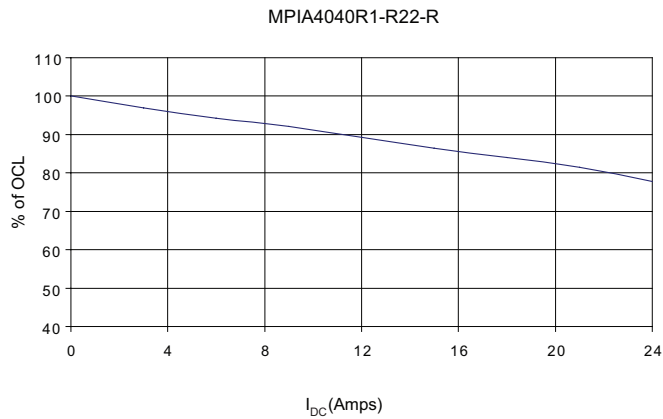
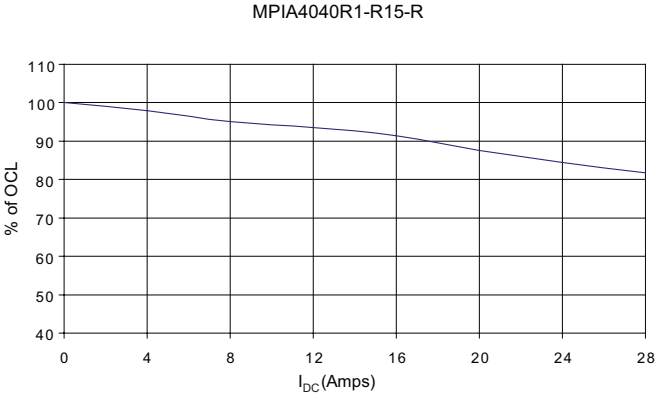
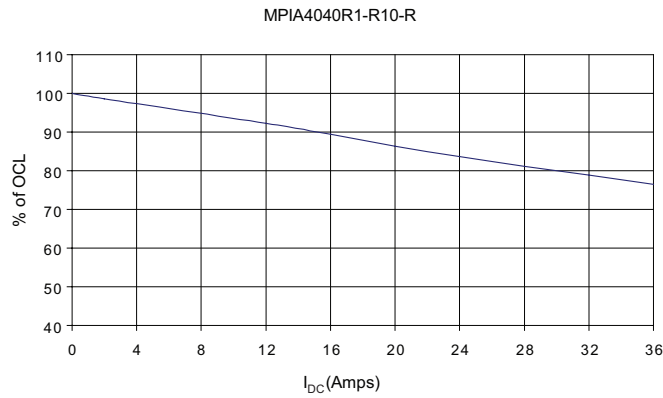
Temperature rise vs. total loss



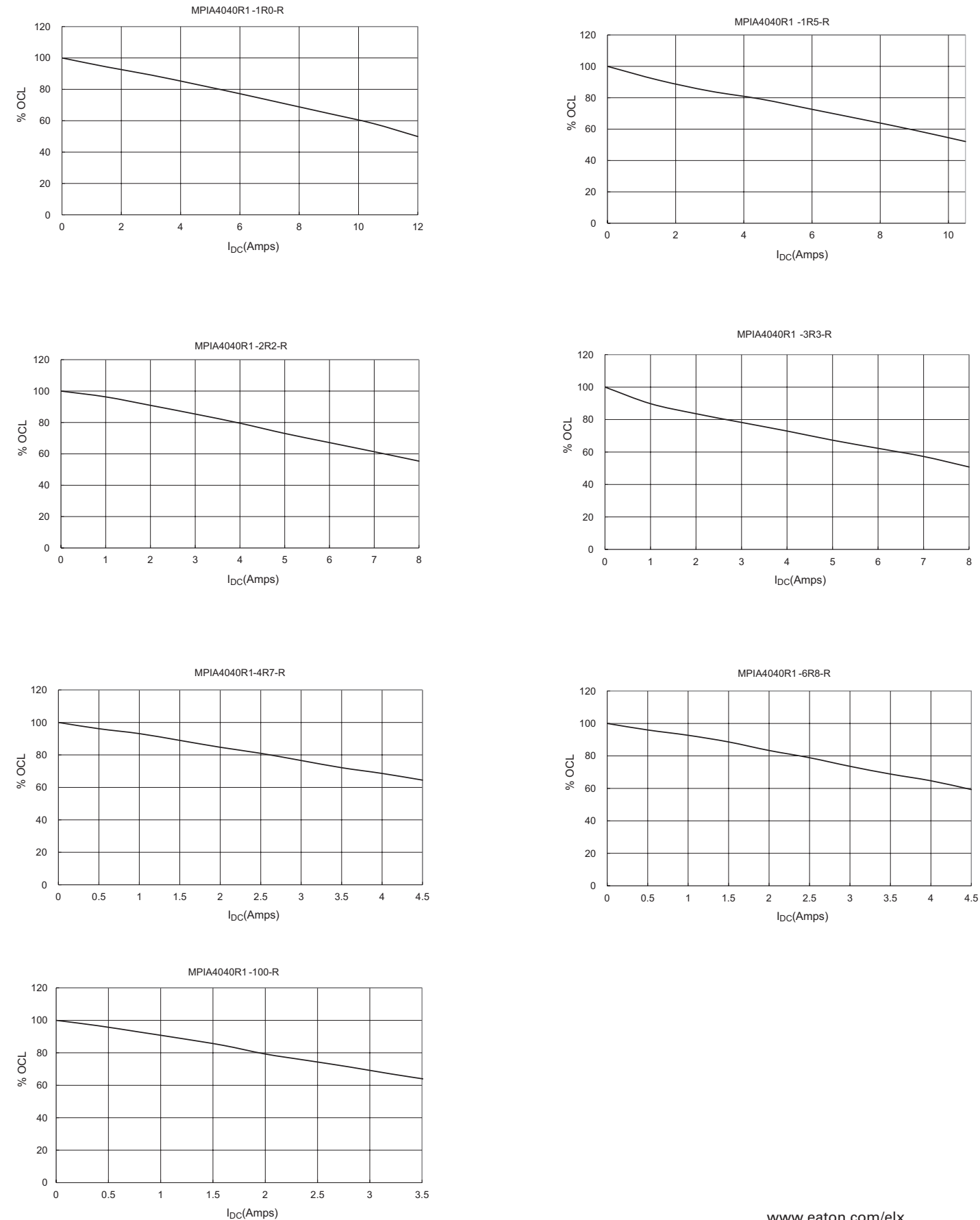
Core loss



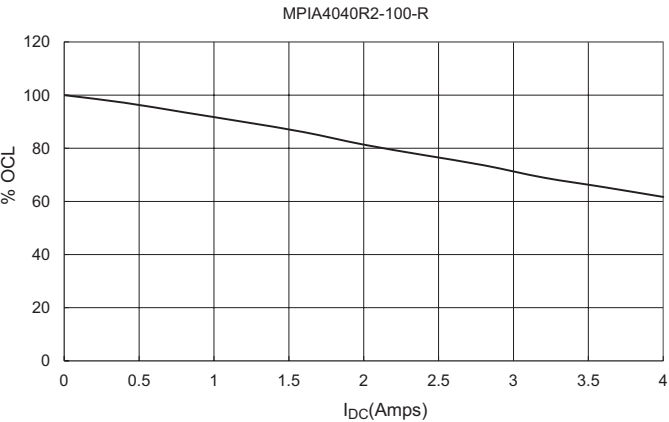
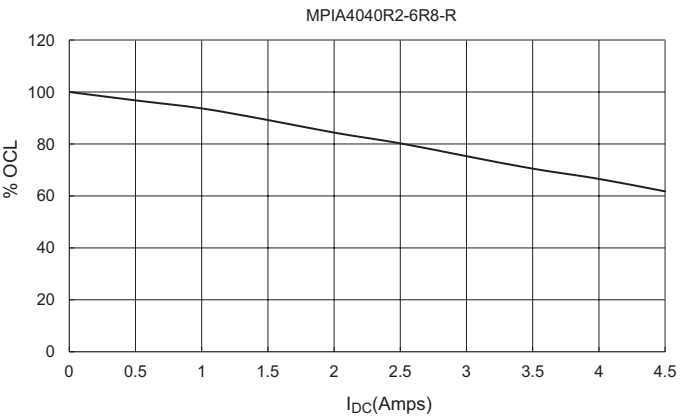
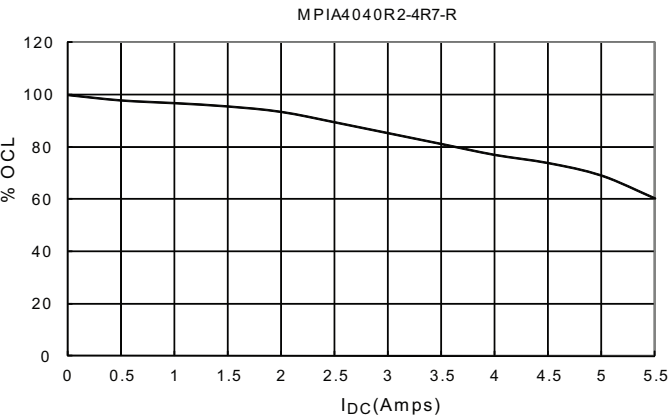
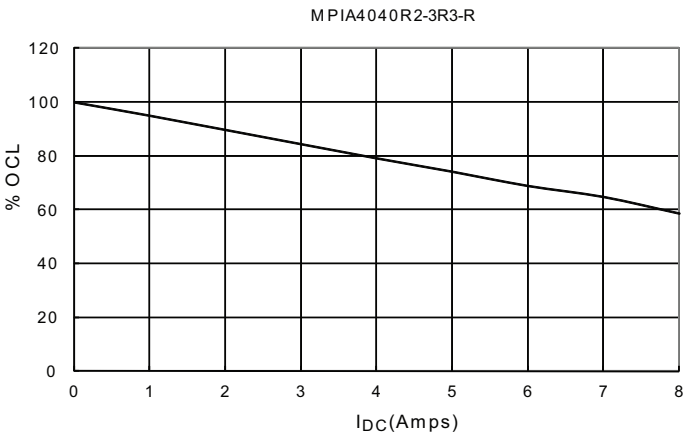
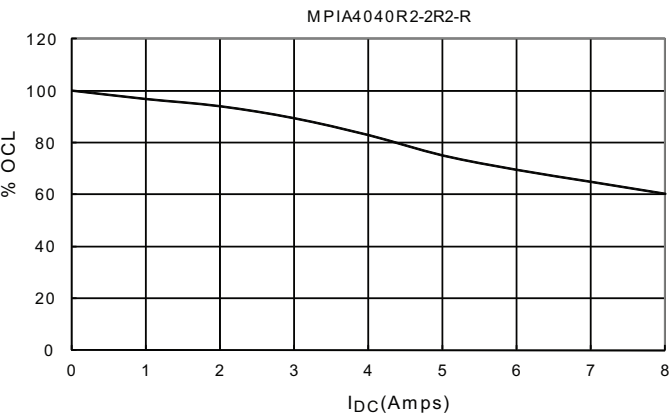
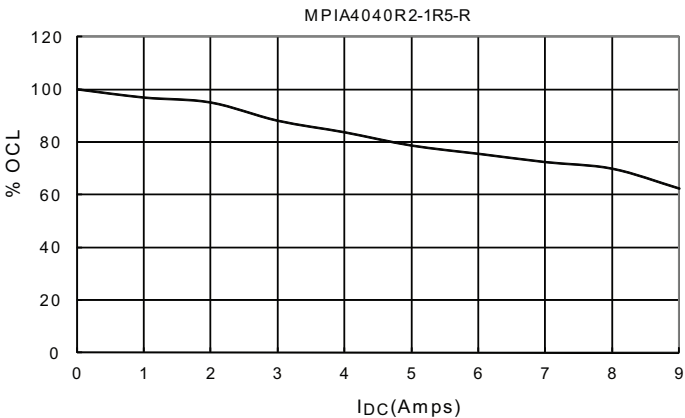
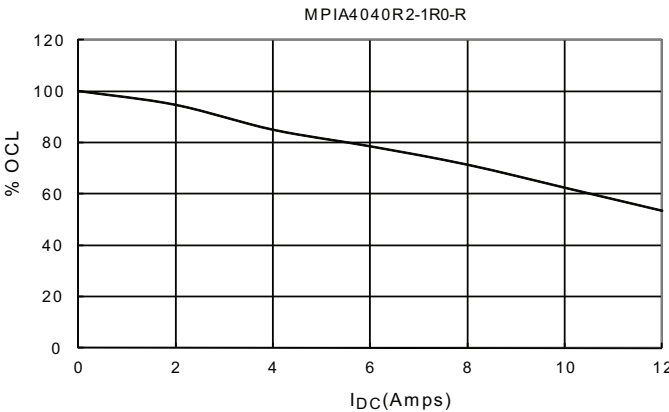
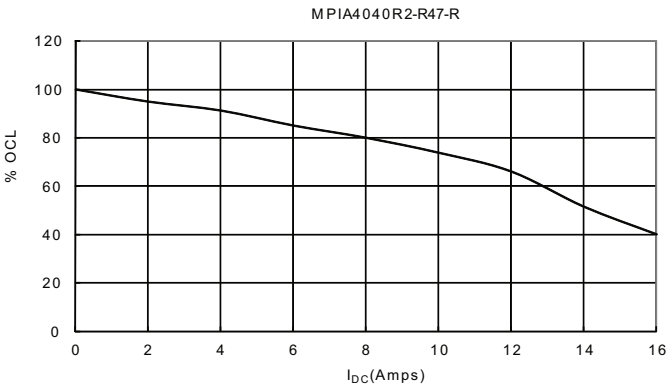
1.2mm Height R1 inductance characteristics — % of OCL vs. I_{DC}



1.2mm Height R1 inductance characteristics — % of OCL vs. I_{DC}

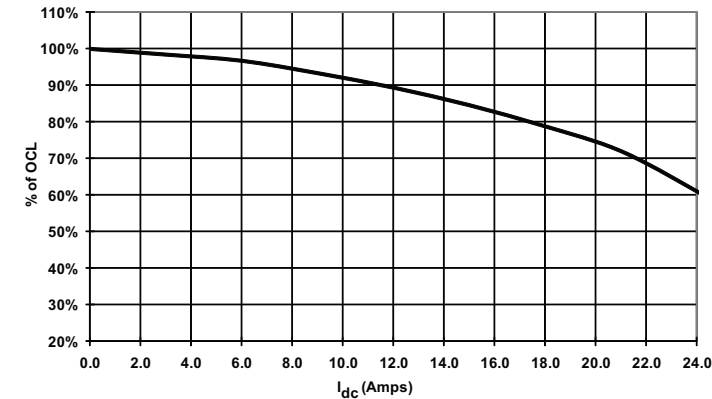


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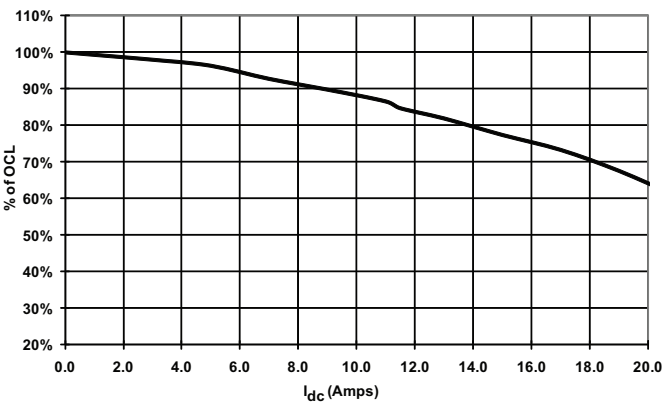


1.85mm Height R3 inductance characteristics — % of OCL vs. I_{DC}

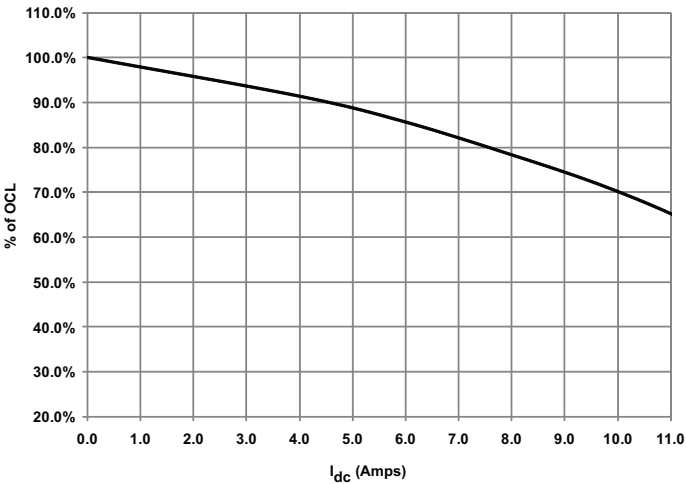
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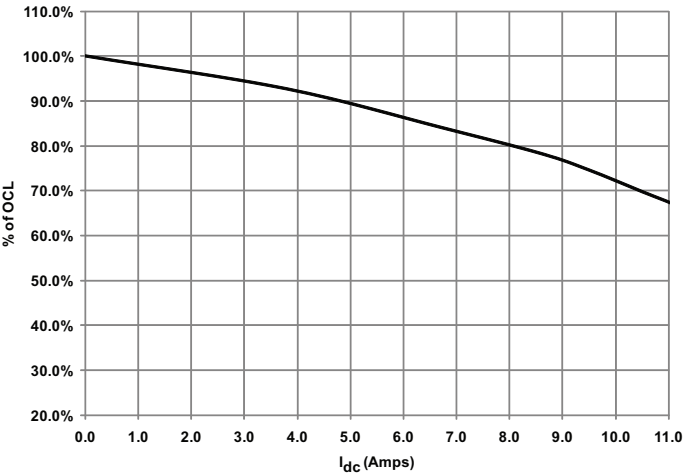
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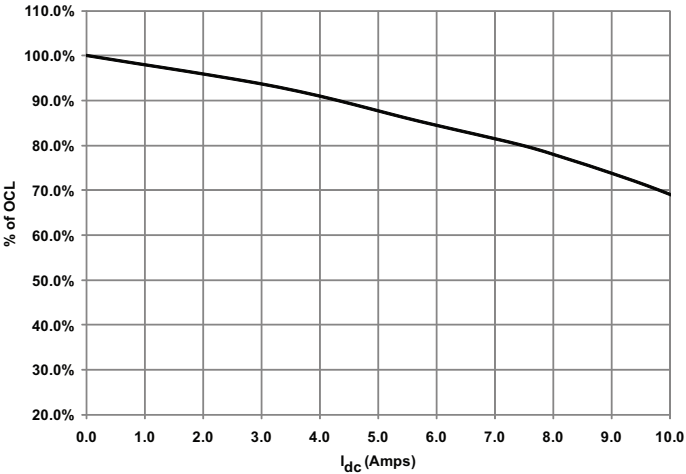
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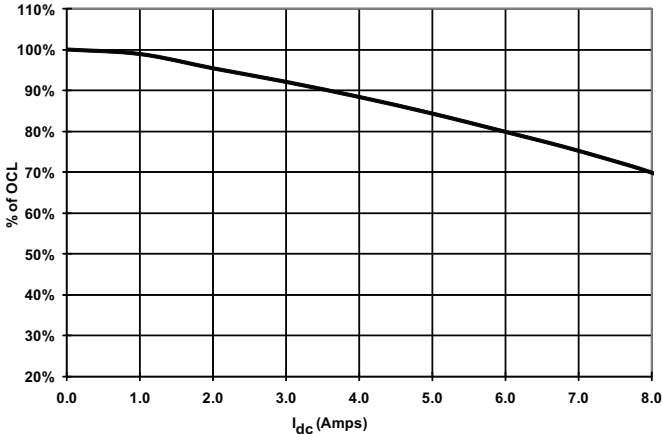
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MPIA4040R3-2R2-R

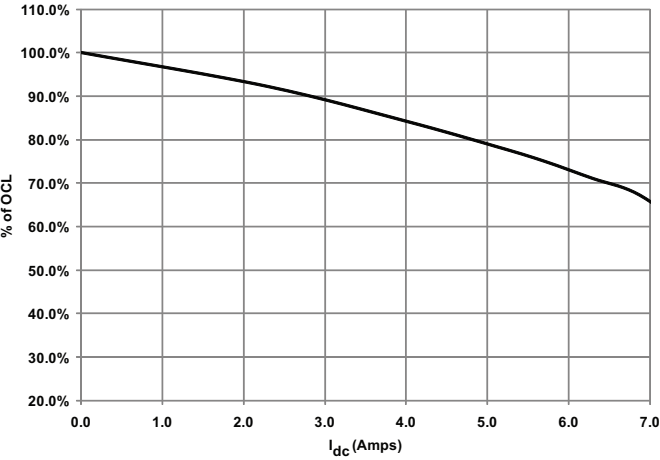


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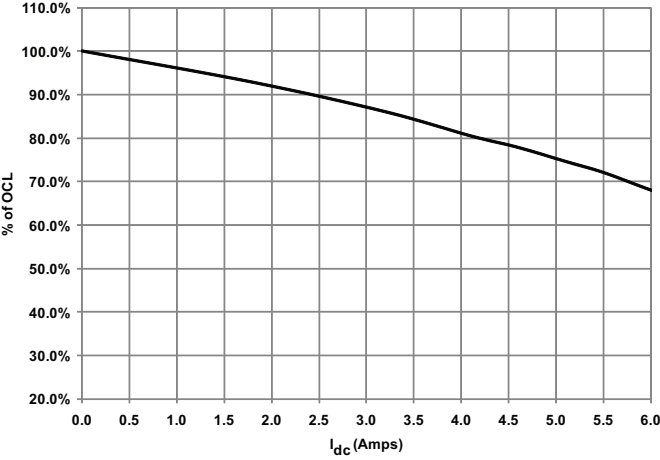


1.85mm Height R3 inductance characteristics — % of OCL vs. I_{DC}

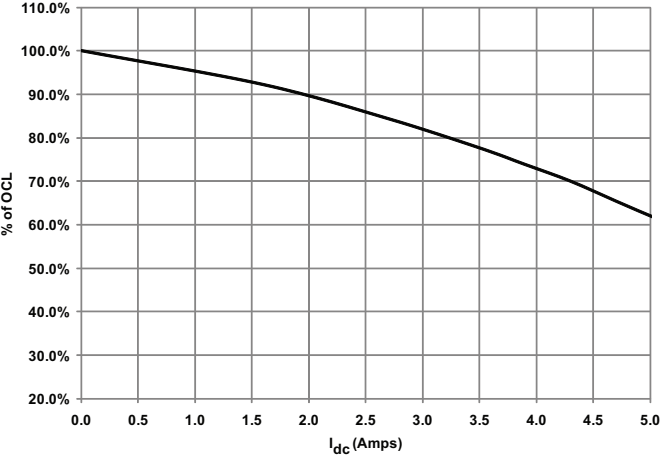
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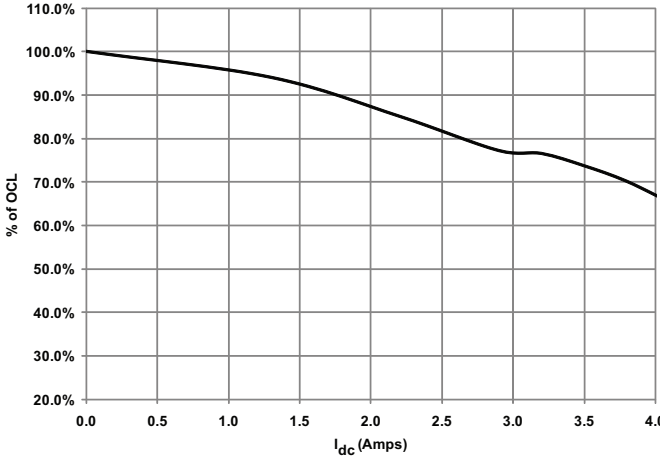
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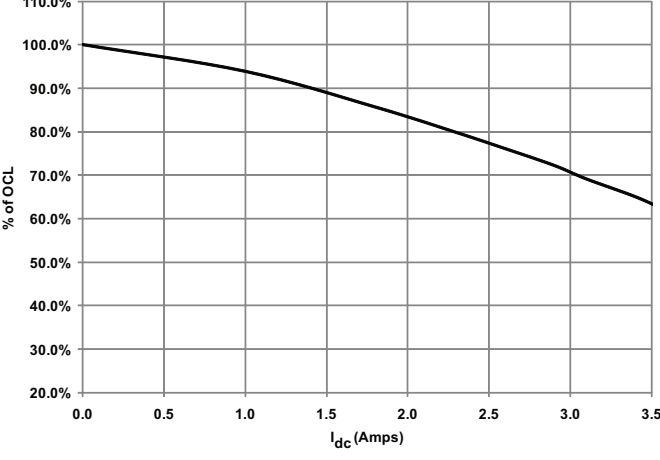
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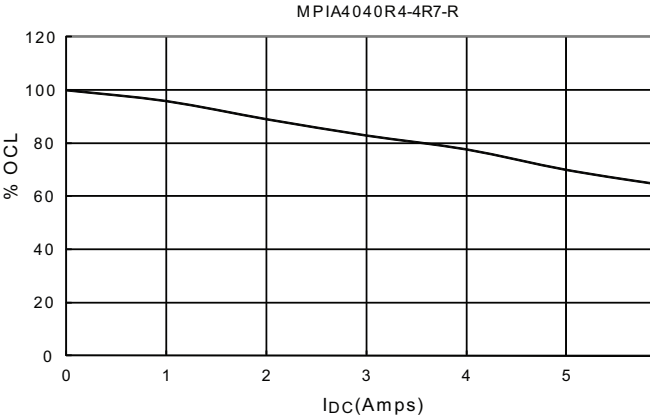
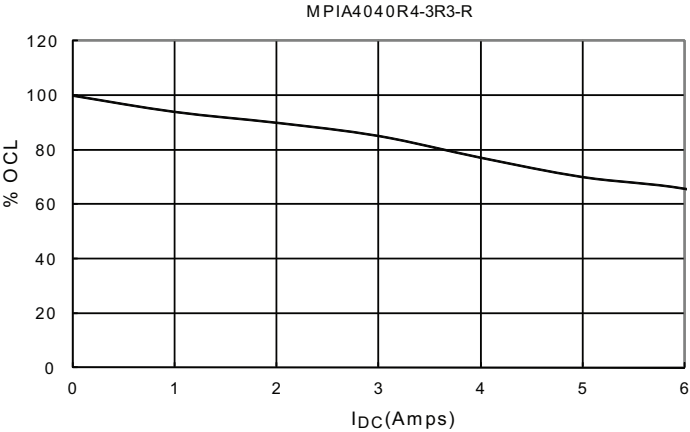
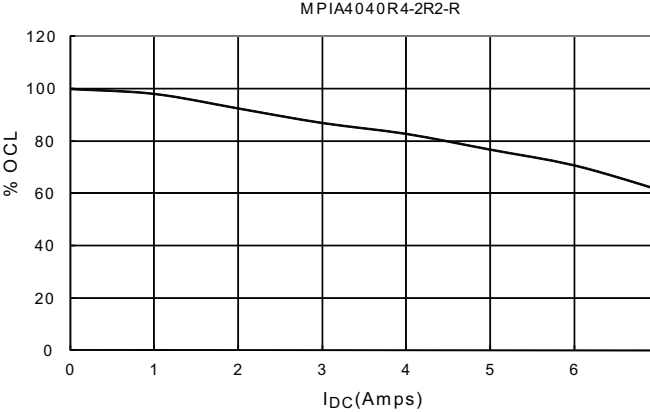
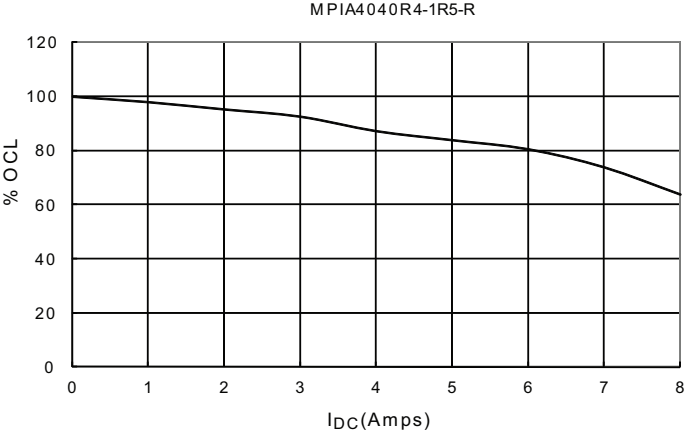
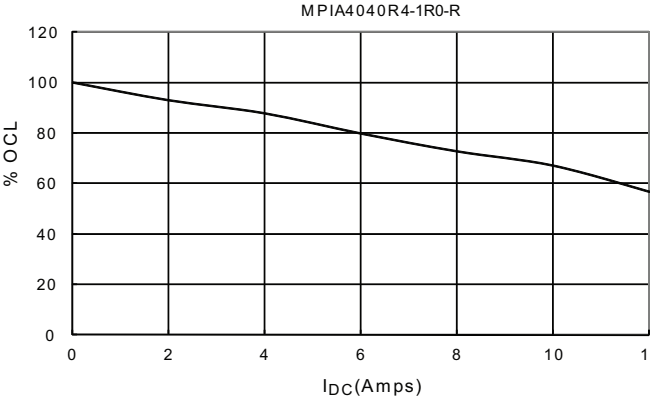
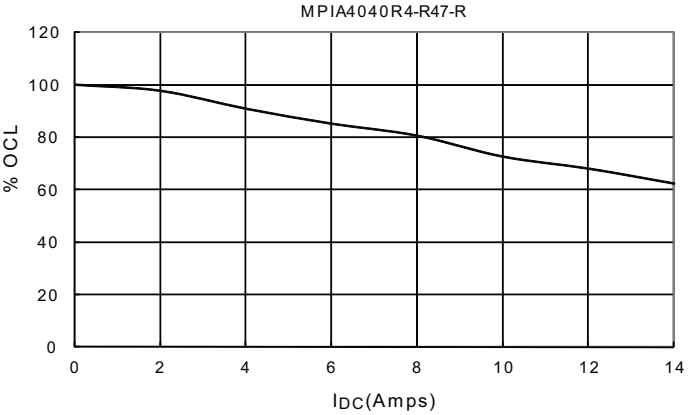
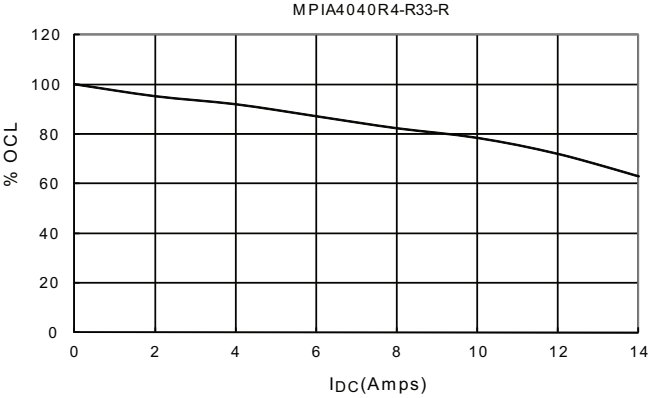
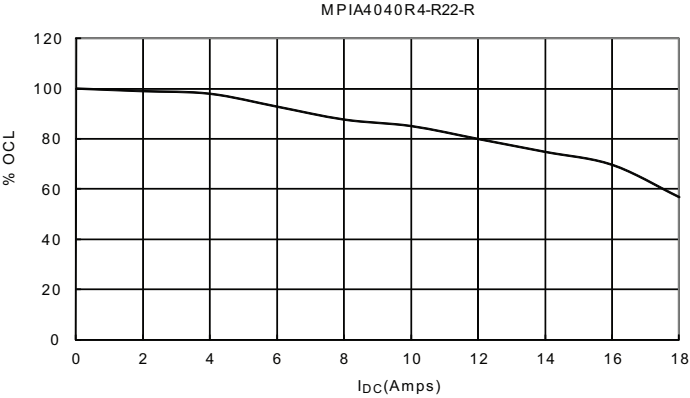
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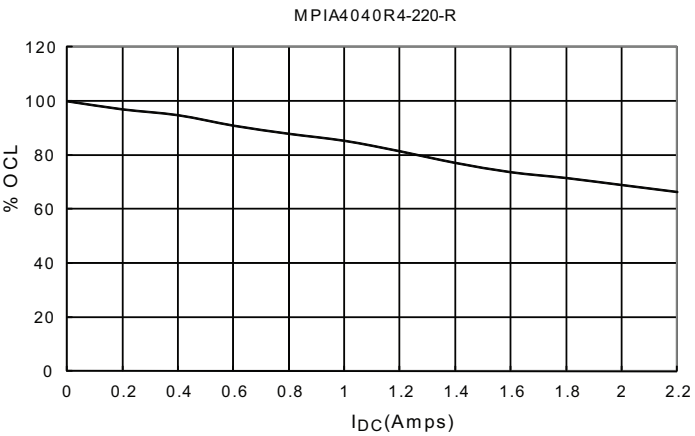
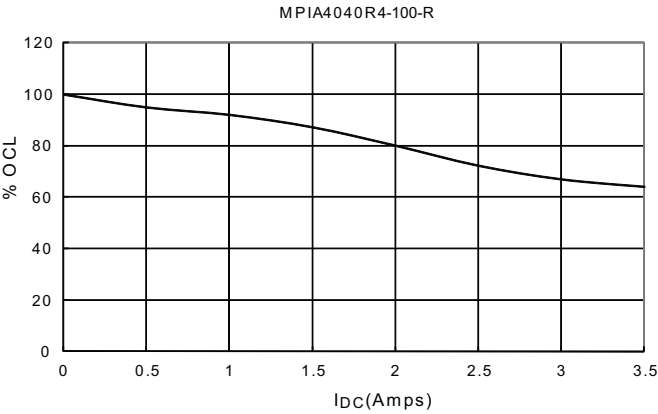
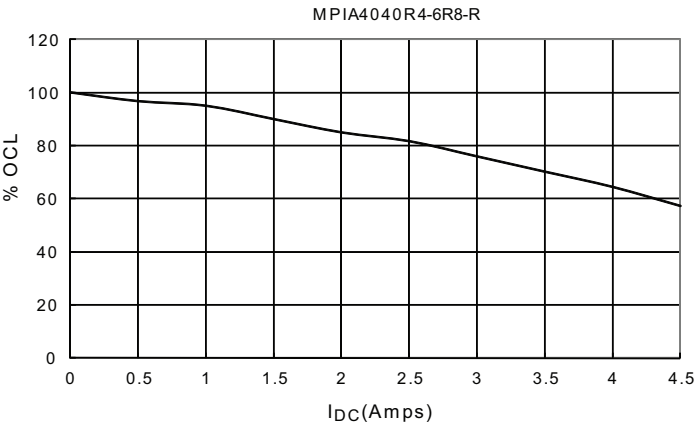
MPIA4040R3-220-R



2.0mm Height R4 inductance characteristics — % of OCL vs. I_{DC}



2.0mm Height R4 inductance characteristics — % of OCL vs. I_{DC}



Solder reflow profile

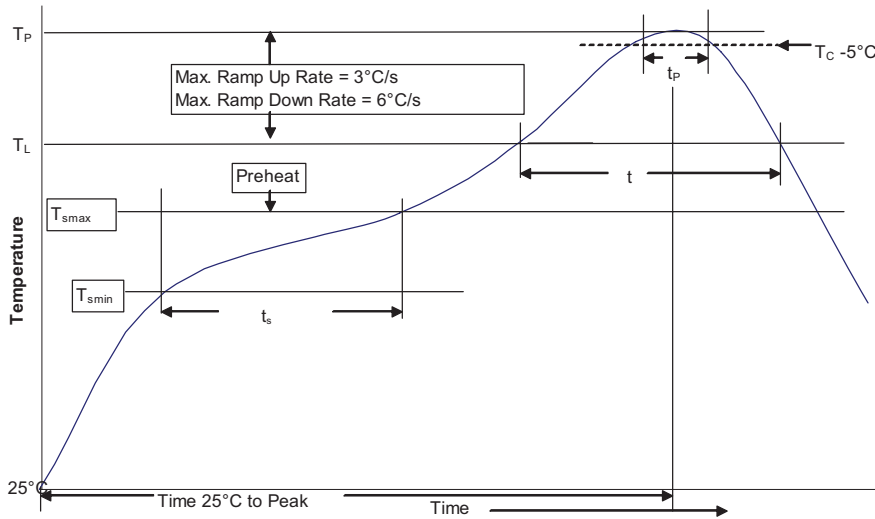


Table 1 - Standard SnPb Solder (T_C)

Package Thickness	Volume mm^3 <350	Volume mm^3 ≥ 350
<2.5mm	235°C	220°C
$\geq 2.5\text{mm}$	220°C	220°C

Table 2 - Lead (Pb) Free Solder (T_C)

Package Thickness	Volume mm^3 <350	Volume mm^3 350 - 2000	Volume mm^3 >2000
<1.6mm	260°C	260°C	260°C
1.6 – 2.5mm	260°C	250°C	245°C
>2.5mm	250°C	245°C	245°C

Reference JEDEC J-STD-020D

Profile Feature	Standard SnPb Solder	Lead (Pb) Free Solder
Preheat and Soak		
• Temperature min. (T_{smin})	100°C	150°C
• Temperature max. (T_{smax})	150°C	200°C
• Time (T_{smin} to T_{smax}) (t_s)	60-120 Seconds	60-120 Seconds
Average ramp up rate T_{smax} to T_P	3°C/ Second Max.	3°C/ Second Max.
Liquidous temperature (T_L)	183°C	217°C
Time at liquidous (t_L)	60-150 Seconds	60-150 Seconds
Peak package body temperature (T_P)*	Table 1	Table 2
Time (t_p)** within 5 °C of the specified classification temperature (T_C)	20 Seconds**	30 Seconds**
Average ramp-down rate (T_P to T_{smax})	6°C/ Second Max.	6°C/ Second Max.
Time 25°C to Peak Temperature	6 Minutes Max.	8 Minutes Max.

* Tolerance for peak profile temperature (T_P) is defined as a supplier minimum and a user maximum.

** Tolerance for time at peak profile temperature (t_p) is defined as a supplier minimum and a user maximum.

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